IR3Y49M1

CCD Signal Process & Digital Interface IC

DESCRIPTION

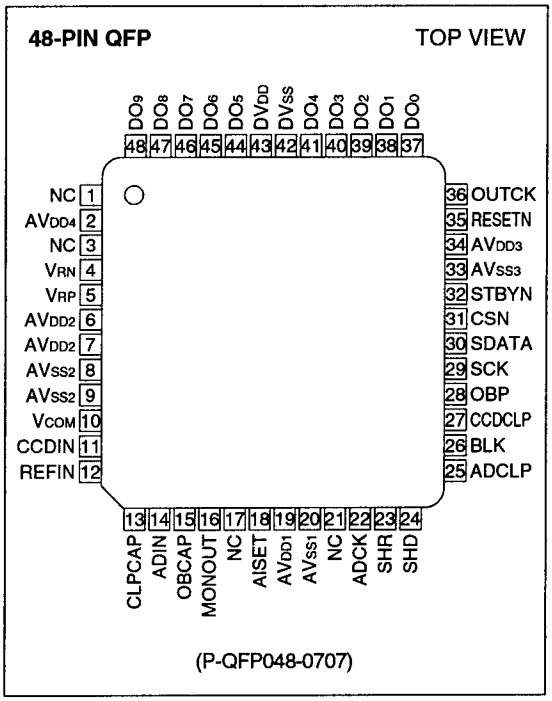
The IR3Y49M1 is a CMOS single-chip signal processing IC for CCD area sensors which includes correlated double sampling circuit (CDS), clamp circuit, programmable gain amplifier (PGA), reference voltage generator, black level detection circuit, 36 MHz 10-bit analog-to-digital converter (ADC), timing generator for internally required pulses, and serial interface for internal function control and PGA gain control.

FEATURES

- Low power consumption : 150 mW (TYP.)
- Wide gain range : 0 to 36 dB
  (Gain step : 0.094 dB/step)
- High speed sample-and-hold circuits :
  pulse width 7 ns (MIN.)
- Black level canceler
  – Settling target : 16 to 127 LSB
- Capable of independent input of ADC conversion clock and data output clock
- Power down mode : less than 0.3 mW
- Built-in serial interface
- 10-bit ADC operating up to 36 MHz
  – DNL : ±0.8 LSB (TYP.)
  – INL : ±2.0 LSB (TYP.)
- Maximum input level of CCD signals : 1.1 Vp-p
- Accepts a direct signal input to ADC or PGA (input level : 1.1 Vp-p (TYP.))
- Single +3 V power supply
- Package :
  48-pin QFP* (P-QFP048-0707) 0.5 mm pin-pitch

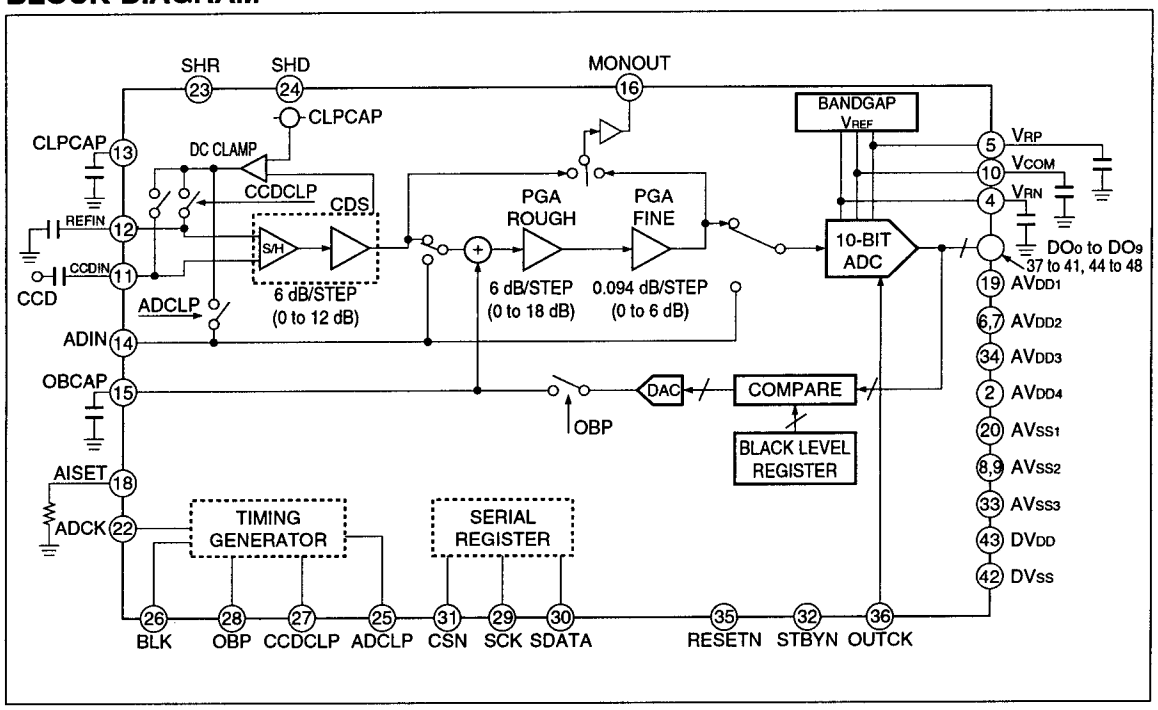
*Contact SHARP in order to obtain the details of package dimensions of the IR3Y49M1.

PIN CONNECTIONS

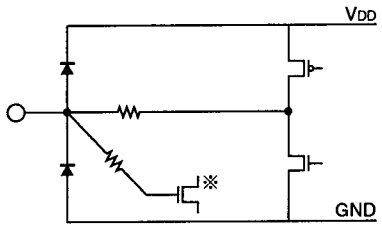
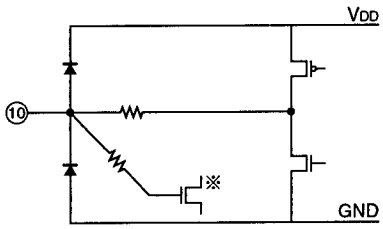
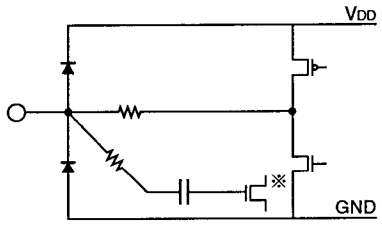
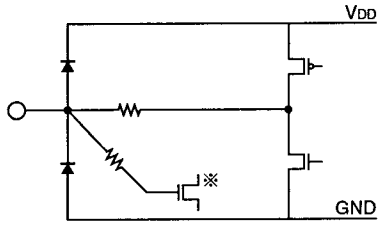


(P-QFP048-0707)

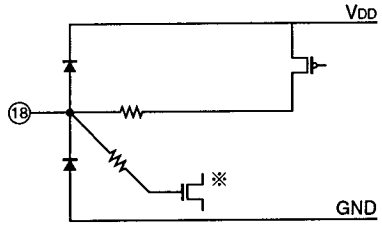
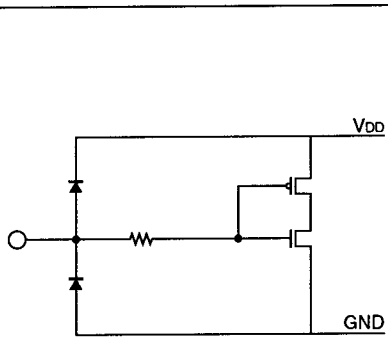
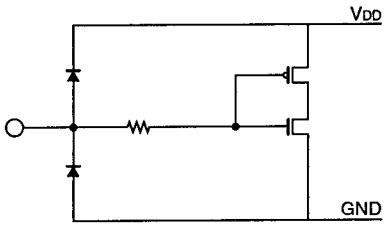
BLOCK DIAGRAM



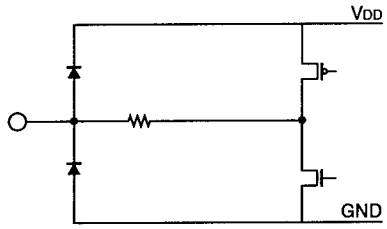
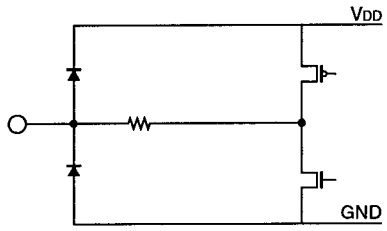
PIN DESCRIPTION

PIN NO.	SYMBOL	I/O	EQUIVALENT CIRCUIT	DESCRIPTION
1	NC	–		No connection.
2	AV_{DD4}	–		Supply of 2.7 to 3.6 V analog power.
3	NC	–		No connection.
4	V_{RN}	O		ADC internal negative reference voltage. (Connect to AVss via 0.1 µF.)
5	V_{RP}	O		ADC internal positive reference voltage. (Connect to AVss via 0.1 µF.)
6	AV_{DD2}	–		Supply of 2.7 to 3.6 V analog power.
7	AV_{DD2}	–		Supply of 2.7 to 3.6 V analog power.
8	AV_{SS2}	–		An analog grounding pin.
9	AV_{SS2}	–		An analog grounding pin.
10	V_{COM}	O		ADC internal common reference voltage. (Connect to AVss via 0.1 µF.)
11	CCDIN	I		CDS circuit data input.
12	REFIN	I		CDS circuit reference input.
13	CLPCAP	O		Clamp level output. (Connect to AVss via 0.1 µF.)
14	ADIN	I		ADIN signal input.
15	OBCAP	O		Black level integration voltage. (Connect to AVss via 0.033 µF.)
16	MONOUT	O		Monitor output of CDS or PGA.

※ Internal FET gate

PIN NO.	SYMBOL	I/O	EQUIVALENT CIRCUIT	DESCRIPTION
17	NC	–		No connection.
18	AISET*	I		Internal analog circuit bias current input. (Connect to AVss via 4.7 kΩ.)
19	AVDD1	–		Supply of 2.7 to 3.6 V analog power.
20	AVSS1	–		An analog grounding pin.
21	NC	–		No connection.
22	ADCK	I		ADC sampling clock input.
23	SHR	I		Reference sampling pulse input.
24	SHD	I		Data sampling pulse input.
25	ADCLP	I		Pulse input for ADIN clamp and black calibration control.
26	BLK	I		Blanking pulse input.
27	CCDCLP	I		Clamp control input.
28	OBP	I		Black level period pulse input.
29	SCK	I		Serial port clock input.
30	SDATA	I		Serial port data input.
31	CSN	I		Serial port chip selection (active at low).
32	STBYN	I		Power down control (power down at low).
33	AVSS3	–		An analog grounding pin.
34	AVDD3	–		Supply of 2.7 to 3.6 V analog power.
35	RESETN	I		Reset signal input (reset at low).
36	OUTCK	I		Clock input for ADC output.

* High-Z at power down ※ Internal FET gate

PIN NO.	SYMBOL	I/O	EQUIVALENT CIRCUIT	DESCRIPTION
37	DO_0*	O		ADC digital output (3 state) (LSB).
38	DO_1*	O		ADC digital output (3 state).
39	DO_2*	O		ADC digital output (3 state).
40	DO_3*	O		ADC digital output (3 state).
41	DO_4*	O		ADC digital output (3 state).
42	DV_{SS}	–		A digital grounding pin.
43	DV_{DD}	–		Supply of 2.7 to 3.6 V digital power.
44	DO_5*	O		ADC digital output (3 state).
45	DO_6*	O		ADC digital output (3 state).
46	DO_7*	O		ADC digital output (3 state).
47	DO_8*	O		ADC digital output (3 state).
48	DO_9*	O		ADC digital output (3 state) (MSB).

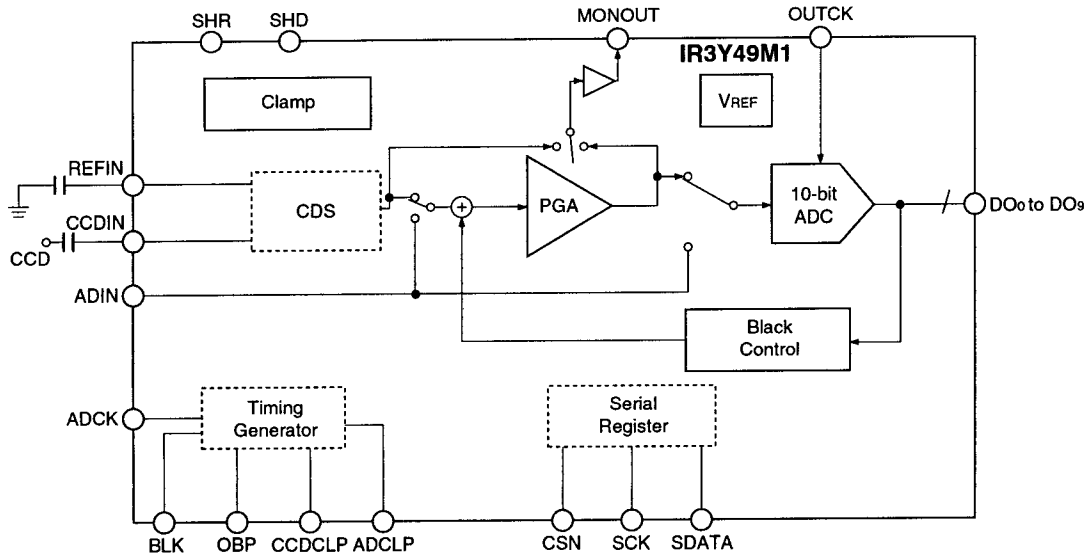
* High-Z at power down

NOTE : NC pins are not connected internally, but recommended to be connected to AV_{SS}.

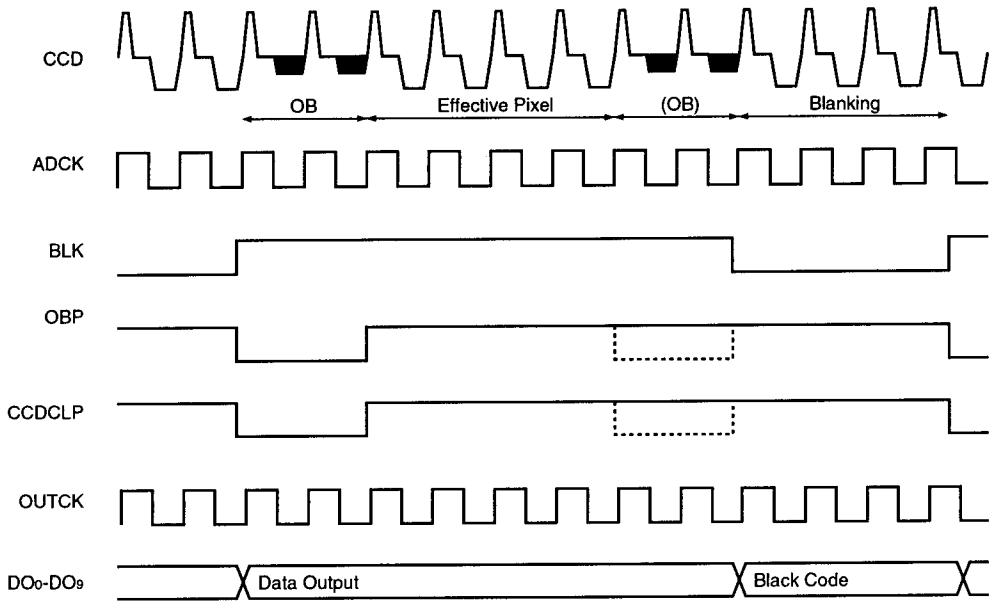
FUNCTIONAL DESCRIPTION

Outline

The configuration of IR3Y49M1 is described below.



GENERAL TIMING



NOTE : In this chart, the cycles of the OBP and CCDCLP show the same timing. But the OBP and CCDCLP can be input at different timing.

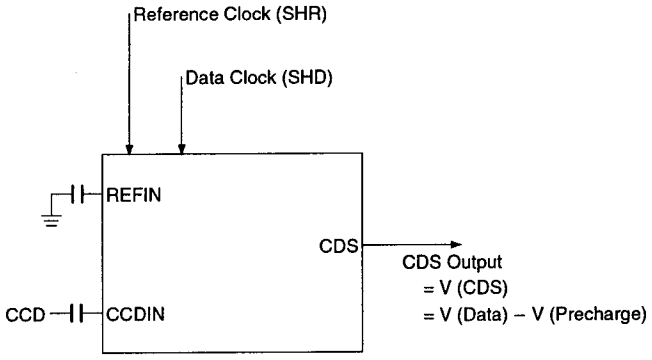
CDS (Correlated Double Sampling) Circuit

CDS circuit holds CCD precharge (reference) level at SHR pulse, then it samples CCD pixel data at SHD pulse. Correlated (common) noise is removed by subtracting precharge level from pixel data level. CDS has the gain of maximum 12 dB (6 dB/step).

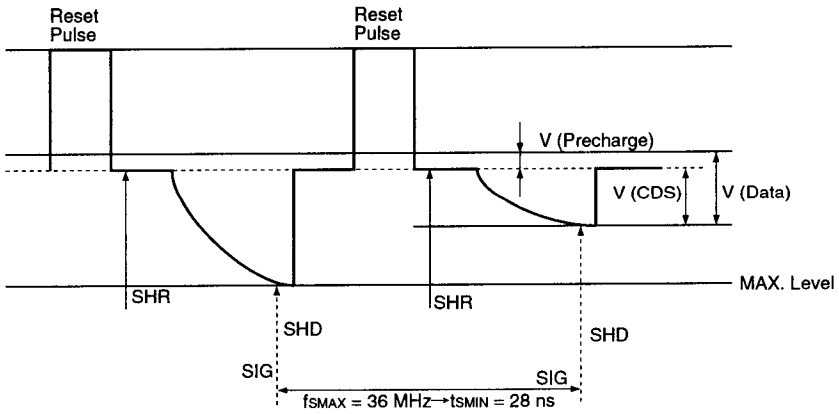
The gain is controlled by setting of PGA gain of serial register as a part of total gain.

Connect signal from CCD sensor to CCDIN pin through C-coupling. Place the same capacitor between REFIN and AVss.

CDS Circuit



CDS Operation

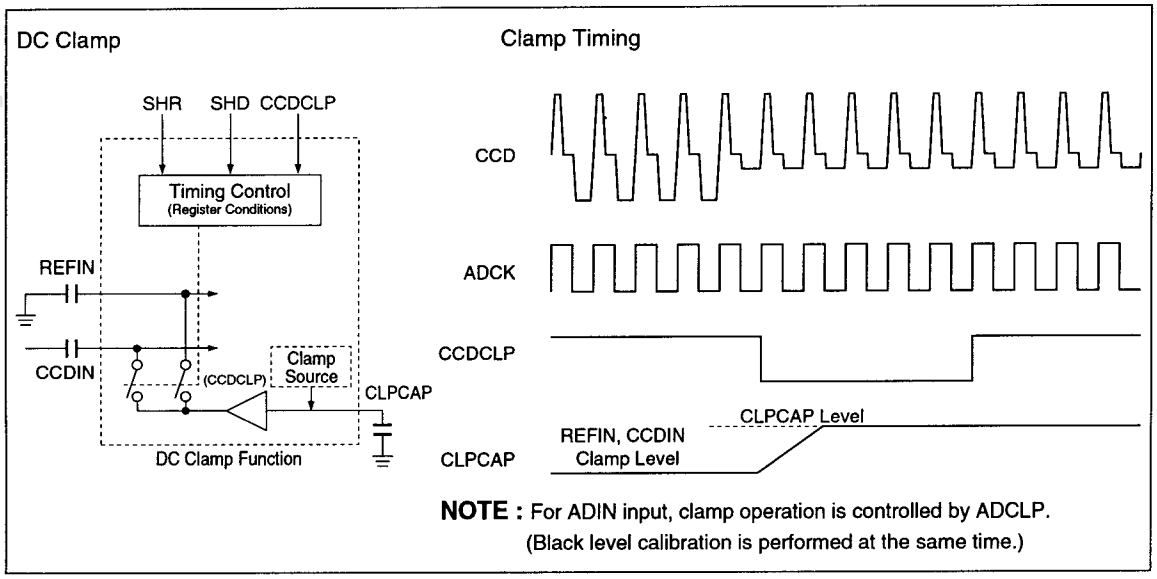


Clamp Circuits

DC CLAMP

DC level of the CCDIN/REFIN input is fixed by internal DC clamp circuit. DC level of C-coupled CCD signal at the CDS input is set to CLPCAP by the internal DC clamp circuit.

Normally clamp switches are turned on at black level calibration period. Place 0.1 µF external capacitance between CLPCAP and AVss.



NOTE : For ADIN input, clamp operation is controlled by ADCLP. (Black level calibration is performed at the same time.)

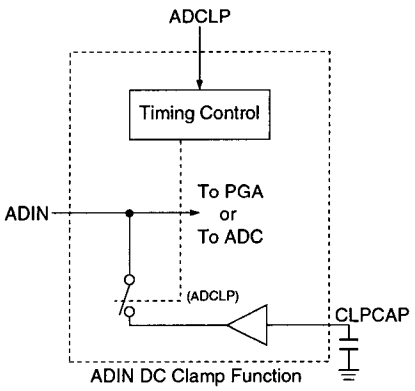
CLAMP OF ADIN SIGNAL

Clamp operation for ADIN path is also available. Note that clamp voltage [CLPCAP] is different between CCDIN/REFIN input and ADIN input.

Clamp operation of ADIN signal can be turned off by register setting.

Clamp circuit is controlled by ADCLP signal at "ADIN signal to ADC" mode. Black level calibration circuit is also controlled by ADCLP at "ADIN signal to PGA" mode.

ADIN DC Clamp



CLAMP CONTROL

Following items are selectable by register setting.

a) Clamp current [Mode (2) Register D7]
Normal or fast clamp is selectable for charge current. (Select normal clamp in general.)

b) Clamp target [Mode (2) Register D5 & D4]
Input signals (REFIN and CCDIN) to be clamped are selectable. It is also possible to turn off the clamp function.

Black Level Cancel Circuit

The purpose of a black level cancel circuit is to control the DC level of the PGA input so that the ADC output code at a optical black period may correspond to the black level code set up by the register. The black level code of (1 to) 16 to 127 LSB (default : 64 LSB) is available.

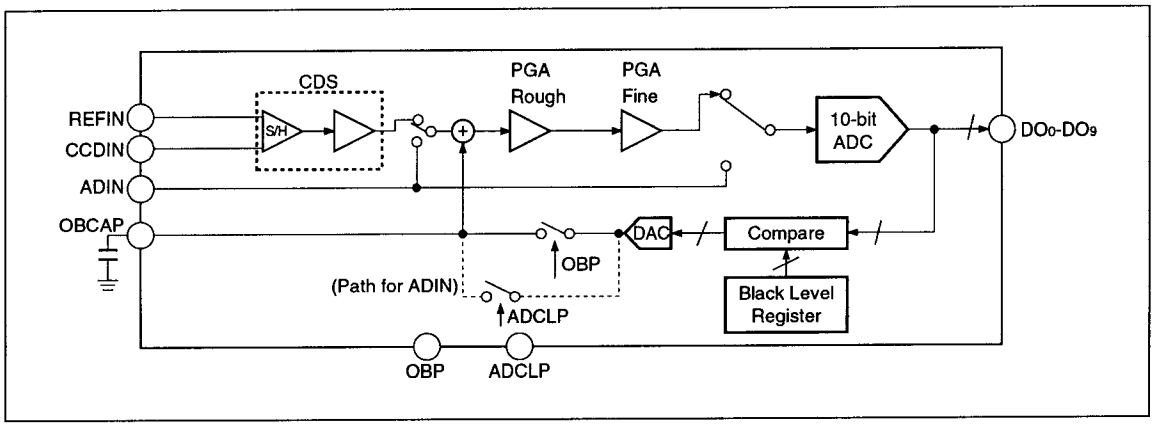
A black level cancel loop is established while the OBP pin is active. In this loop, the ADC output code is compared with the black level code and the voltage of the OBCAP capacitor is controlled by the result. Thus, the OBCAP voltage settles gradually, and the signal level of the optical black period corresponds to the established value.

The charge of the OBCAP capacitor is reset under following conditions :

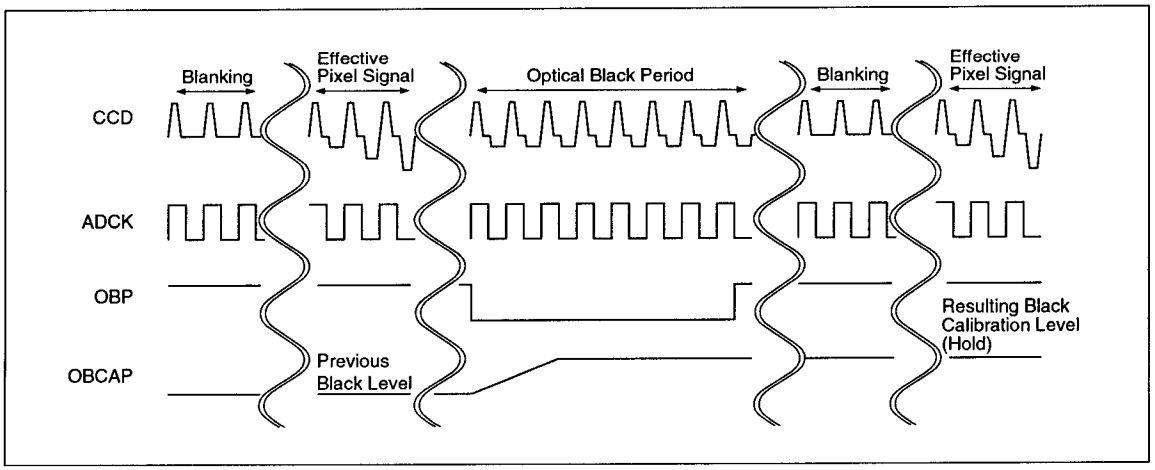
① Set the black level reset register to "1". [Mode (1) Register D_1 = 1]
② Set the RESET pin to low.
③ Power down (by the STBYN pin or register control)

The DC clamping [CCDCLP] is allowed while the OBP pin is low.

The black level cancellation is also available in "ADIN signal to PGA" mode. (See the broken line path of **"Black Level Calibration"** below.) The black level cancellation is available at the ADCLP period in this mode. (That means a clamping and a black level cancelling are done simultaneously.)



Black Level Calibration



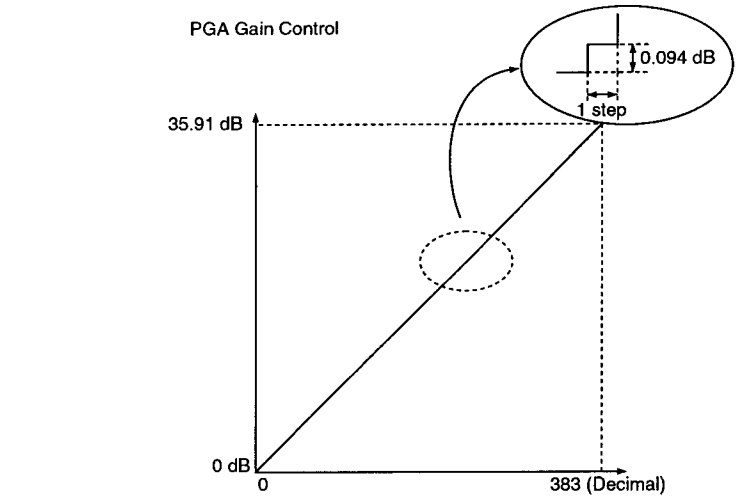
Black Level Calibration Timing

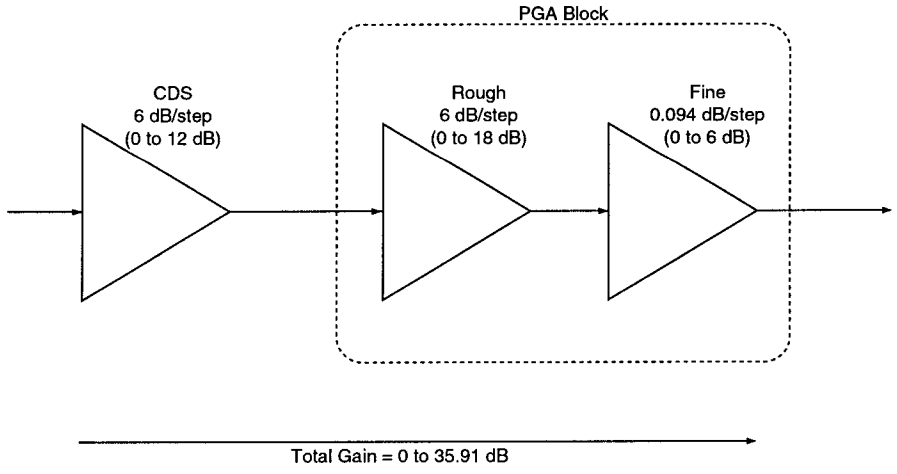
Gain Control Circuit

The total gain for CCD input signal covers from 0 to 36 dB.

This range consists of CDS (0 to 12 dB (6 dB/step)), PGA rough (0 to 18 dB (6 dB/step)), and PGA fine (0 to 6 dB (0.094 dB/step)). Total gain is controlled (as described below) by 9-bit gain control register. The gain is fixed at maximum gain when the code exceeds 382 (decimal).

The gain of ADIN (which bypasses CDS) is 0 to 24 dB.





NOTES :

- The gain of the ADIN (PGA) input pass can be set from 0 to 24 dB.
- Total gain specified relative gain from the minimum gain.

Gain Control

A/D Converter Circuit

The IR3Y49M1 integrates an 36 MHz 10-bit full pipeline A/D converter (ADC).

This ADC converts following signals :

1. The signal from the CCDIN input through a CDS and a PGA
2. The signal from the ADIN input through a PGA at the ADIN (PGA input) mode.
3. The signal from the ADIN input at the ADIN (ADC input) mode.

A/D CONVERSION RANGE

The analog input range of the ADC is determined by the internal reference voltage.

The full scale of the ADC is 1.1 Vp-p (single end).

A/D CONVERTER OUTPUT CODE (AT MODE (1) REGISTER D_5 = 1)

The format of an ADC digital output is a straight binary.

Thus, when input a zero reference voltage, the output code is "all 0", and when input a full scale voltage, the output code is "all 1".

CLOCK, PIPELINE DELAY, DIGITAL DATA OUTPUT TIMING

The ADCK input is used for an A/D conversion.

The ADC input signal is sampled at the falling edge of the ADCK input and 10-bit parallel data is output at the rising edge of the ADCK input after 5.5 clocks of pipeline delay.

HIGH-Z CONTROL OF ADC DIGITAL OUTPUT

ADC digital outputs become High-Z under following conditions :

① Set the ADC output bit to "1".
[Mode (1) Register D_2 = 1]

② Set the SYBYN pin to low.

③ Set the power control bit to "1".
[Mode (1) Register D_0 = 1]

ADC Data Output (Coding : Straight Binary)

A/D INPUT	DIGITAL OUTPUT CODE									
	MSB									LSB
	D_9	D_8	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0
Full scale	1	1	1	1	1	1	1	1	1	1
:					:					
:	1	0	0	0	0	0	0	0	0	0
:	0	1	1	1	1	1	1	1	1	1
:					:					
Clamp reference	0	0	0	0	0	0	0	0	0	0

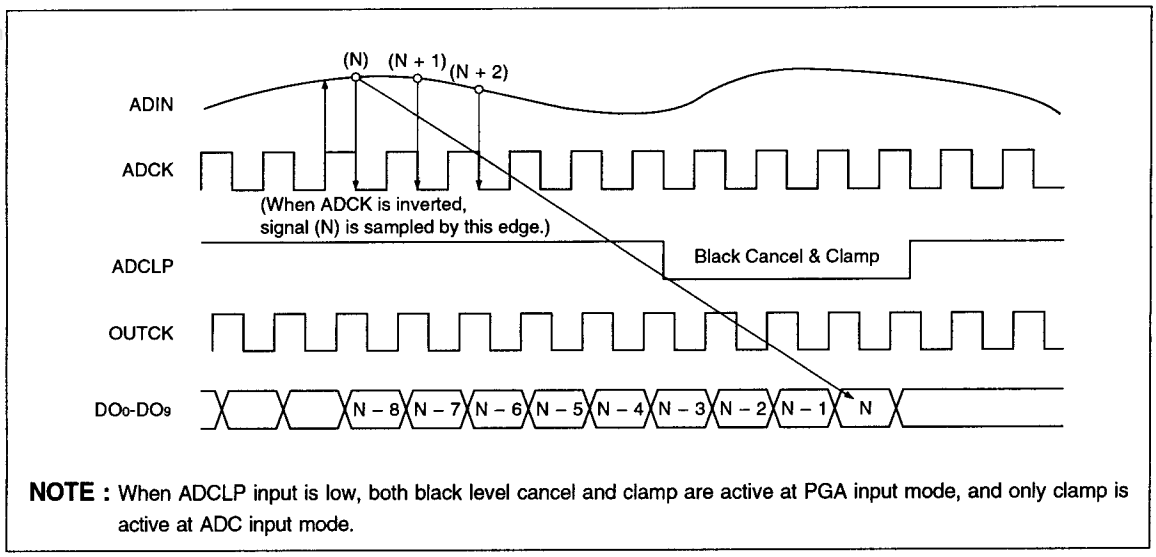
Miscellaneous Functions

ADC DIRECT INPUT (ADIN MODE)

The direct input path to the ADC or the PGA becomes available by the register setting. The selectable paths are showed below :

1. Function disable (default)
   [Mode (1) Register D_5 = 0, D_4 = 0]
2. ADIN input to the PGA
   [Mode (1) Register D_5 = 0, D_4 = 1]
3. ADIN input to the ADC
   [Mode (1) Register D_5 = 1, D_4 = don't care]

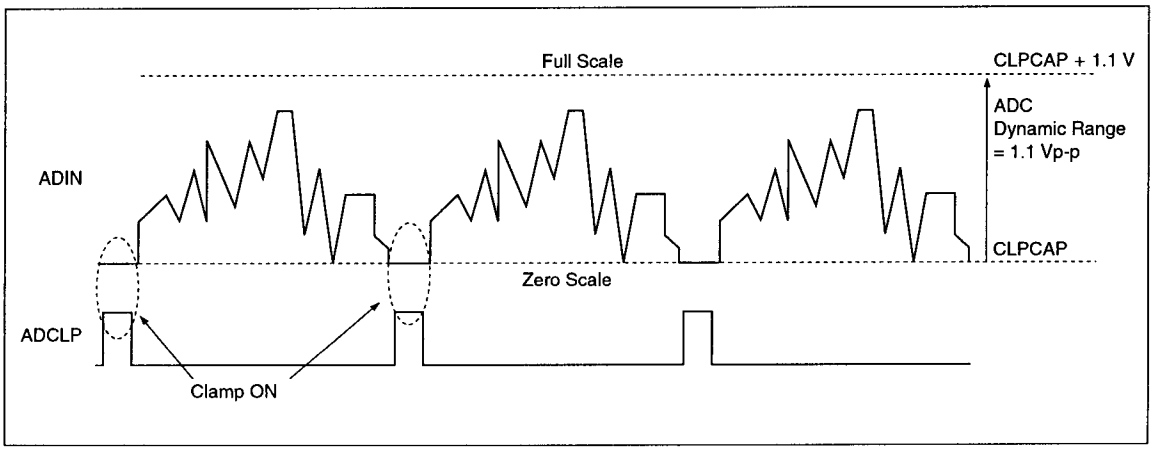
At the ADIN mode, the BLK, SHD and SHR inputs are ignored.



NOTE : When ADCLP input is low, both black level cancel and clamp are active at PGA input mode, and only clamp is active at ADC input mode.

ADIN Signal Processing (PGA Input)

The operation at ADC direct input is shown below. Thus, the clamped level at the ADCLP timing becomes a reference (CLPCAP at the figure below), and the ADIN input dynamic range is +1.1 V (TYP.) from the reference level.



ADIN Signal Input Level

POWER DOWN MODE

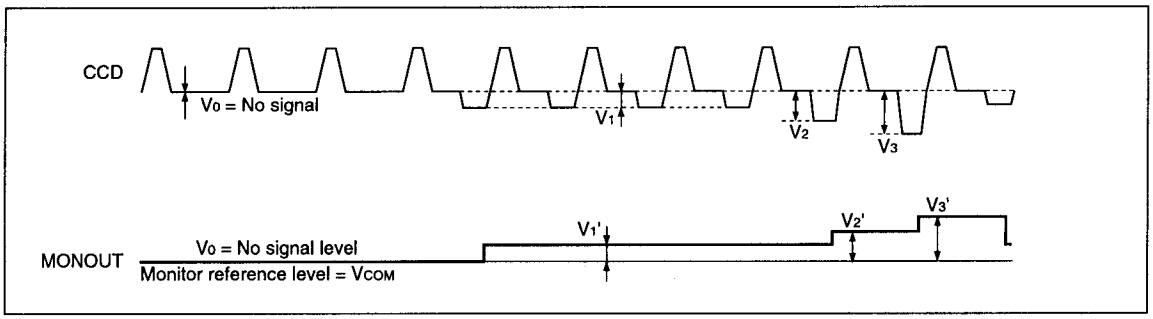
The power down mode can be set either by register setting or STBYN pin.
If one of them is set, the IR3Y49M1 powers down. ("OR" logic)

MONITOR OUTPUT

By setting the register [Mode (2) Register D_1 & D_0], the signal from MONOUT is selectable. Alternatives are OFF, CDS output, PGA output, or REFIN/CCDIN output. Note that the gain of the MONOUT pin is fixed to 0 dB regardless the setting of gain control register when the CDS output is selected. The output level of MONOUT is shown below. The MONOUT level becomes V_{COM} at zero reference level. The signals are output in reverse for the CCD input. The output level of MONOUT becomes approx. −2 to −3 dB for the input amplitude.

CAUTION :

V_{COM} pin can not drive an external circuit.



Monitor Output Level

POLARITY INVERSION

The following input polarities can be inverted by register setting :

① ADCK (A/D converter sampling clock)
[Mode (1) Register D_6]

② SHR and SHD (CDS sampling clock)
[Mode (2) Register D_3 & D_2]

③ BLK, OBP, CCDCLP and ADCLP (Enable controls)
[Mode (2) Register D_3 & D_2]

Data Output Clock

The ADCK input or the OUTCK input is selectable as a ADC data output clock.

General Notice for Power Supply

It is recommended to supply power to both AV_{DD} and DV_{DD} from a single regulator.

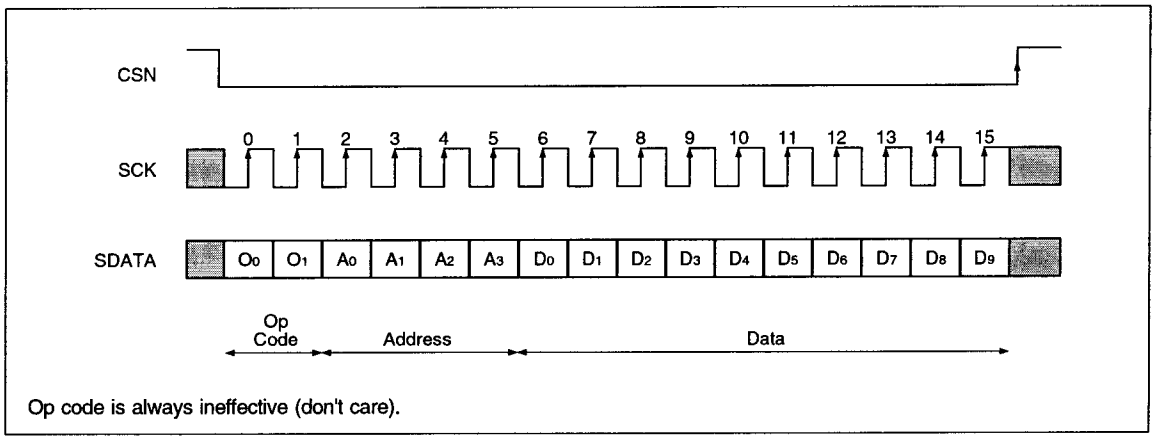
(Keep the absolute maximum rating : $DV_{DD} \leq (AV_{DD} + 0.3\ V)$ even at the power-up and power-down sequence.)

Refer to "**APPLICATION CIRCUIT EXAMPLE**" for power supply decoupling.

Serial Interface Circuit

The internal registers of IR3Y49M1 are controlled by the 3-wire serial interface. The data is a 16-bit-length serial data that consists of a 2-bit operation code, a 4-bit address, and a 10-bit data. The each bit is fetched at the rising edge of the SCK input and the data is executed at the rising edge of the CSN input. When not access, make the CSN input high.

It is prohibited to write to a non-defined address. When a data length is below 16-bit, the data is not executed.



Serial Interface Write Control

Registers

The IR3Y49M1 has 10-bit x 6 registers to control its operations. Two of the seven registers are used for the LSI testing.

All registers are write only. The serial registers are written by serial interface.

Register Map

R/W	ADDRESS				REGISTER NAME	MAJOR FUNCTIONS [DATA]
	A_3	A_2	A_1	A_0		
W	0	0	0	0	Mode (1)	ADCK polarity/ADIN connection/BLK cancel loop/ADC output/Black level reset/Power down
W	0	0	0	1	Mode (2)	Clamp current/ADIN clamp/Clamp target/ S/H, enable logic/Monitor selection
W	0	0	1	0	Gain	Total gain
W	0	0	1	1	Black level	ADC code at black level (1 LSB step)
W	0	1	0	0	Test (1)	Test mode (1) (ADIN coupling mode)
W	0	1	0	1	Test (2)	Test mode (2)

1. Register name Mode (1)
2. Register address
   [Write]

A_3	A_2	A_1	A_0
0	0	0	0

3. Register bit assignment

	D_9	D_8	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0
Default	X	X	X	0	0	0	0	0	0	0
Functions										
ADCK polarity				<->						
ADIN connection					<---->					
BLK cancel loop							<->			
ADC output								<->		
Black level reset									<->	
Power down										<->

X : Don't care

4. Register operations

	CONTROLS										OPERATIONS	NOTE
	D_9	D_8	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0		
ADCK polarity				0							Normal operation as timing chart	
				1							ADCK clock inversion	1
ADIN connection					0	0					ADIN function OFF	
					0	1					ADIN signal to PGA	
					1	X					ADIN signal to ADC	
BLK cancel loop							0				Normal operation [Black cancel]	
							1				OB cancel loop OFF	2
ADC output								0			Normal operation [ADC data output]	
								1			ADC output High-Z [or logic of STBYN]	3
Black level reset									0		Normal operation	
									1		Black level reset [or logic of RESETN]	4
Power down										0	Normal operation	
										1	Power down [or logic of STBYN]	

X : Don't care

NOTES :

1. D_0 to D_9 are output at the rising edge of ADCK in clock inversion mode.
2. Black cancel loop ON/OFF control
   At D_3 = 1, black cancel loop is turned off.
   And fixed value [64 (decimal)] is set to comparator of black level control.
3. ADC output is set to high impedance if one of the following case is true.
   Case 1 : Set "ADC output" bit to "1".
   Case 2 : Set STBYN pin to low.
   Case 3 : Set "Power down" bit to "1".
4. Black level integral CAP [OBCAP] is discharged if the following case is true.
   Case 1 : Set "Black level reset" to "1".
   Case 2 : Set RESETN pin to low.

1. Register name Mode (2)
2. Register address
   [Write]

A3	A2	A1	A0
0	0	0	1

3. Register bit assignment

	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Default	X	X	0	0	0	0	0	0	0	0
Functions										
Clamp current			<->							
ADIN clamp				<->						
Clamp target					<---->					
S/H, enable logic							<---->			
Monitor selection									<---->	

X : Don't care

4. Register operations

	CONTROLS										OPERATIONS	NOTE
	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0		
Clamp current			0								Normal clamp	
			1								Fast clamp	
ADIN clamp				0							Clamp operation active for ADIN	
				1							No clamp for ADIN	
Clamp target					0	0					Normal mode [clamp both REFIN & CCDIN]	
					0	1					Clamp REFIN only	
					1	0					Clamp CCDIN only	
					1	1					Clamp OFF	
S/H, enable logic							0	0			Normal operation as timing chart	
							0	1			S/H control polarity inversion	1
							1	0			Enable control polarity inversion	2
							1	1			Both of S/H and enable inversion	
Monitor selection									0	0	Monitor OFF	
									0	1	CDS signal to monitor	3
									1	0	PGA output monitor	4
									1	1	Output REFIN and CCDIN (for calibration)	

NOTES :

1. The S/H signals are SHR and SHD.
2. The enable controls are BLK, OBP, CCDCLP, and ADCLP.
3. At this mode, monitor output gain = 0 dB regardless of CDS gain.
4. At this mode, monitor output depends on CDS gain.

1. Register name Gain
2. Register address
   [Write]

A_3	A_2	A_1	A_0
0	0	1	0

3. Register bit assignment

	D_9	D_8	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0
Default	X	0	0	0	0	0	0	0	0	0
Functions										
Total gain		<----------								---------->

X : Don't care

4. Register operations

	CONTROLS										DECIMAL	HEX	TOTAL GAIN (dB)	NOTE
	D_9	D_8	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0				
Total gain		0	0	0	0	0	0	0	0	0	0	0	0.000	1
(For CCDIN input)		0	0	0	0	0	0	0	0	1	1	1	0.094	
		0	0	0	0	0	0	0	1	0	2	2	0.188	
		0	0	0	0	0	0	0	1	1	3	3	0.281	
		0	0	0	0	0	0	1	0	0	4	4	0.375	
					...									
		0	0	0	1	1	1	1	1	0	62	3E	5.813	
		0	0	0	1	1	1	1	1	1	63	3F	5.906	
		0	0	1	0	0	0	0	0	0	64	40	6.000	
		0	0	1	0	0	0	0	0	1	65	41	6.094	
					...									
		0	1	0	0	0	0	0	0	0	128	80	12.000	
					...									
		0	1	1	0	0	0	0	0	0	192	C0	18.000	
					...									
		1	0	0	0	0	0	0	0	0	256	100	24.000	
					...									
		1	0	1	0	0	0	0	0	0	320	140	30.000	
					...									
		1	0	1	1	1	1	1	0	0	380	17C	35.625	
		1	0	1	1	1	1	1	0	1	381	17D	35.719	
		1	0	1	1	1	1	1	1	0	382	17E	35.813	
		1	0	1	1	1	1	1	1	1	383	17F	35.906	
		1	1	0	0	0	0	0	0	0	384	180	35.906	
					...									2
		1	1	1	1	1	1	1	1	1	511	1FF	35.906	

	CONTROLS										DECIMAL	HEX	TOTAL GAIN (dB)	NOTE
	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0				
Total gain		0	0	0	0	0	0	0	0	0	0	0	0.000	1
(For PGA input)		0	0	0	0	0	0	0	0	1	1	1	0.094	
		0	0	0	0	0	0	0	1	0	2	2	0.188	
		0	0	0	0	0	0	0	1	1	3	3	0.281	
		0	0	0	0	0	0	1	0	0	4	4	0.375	
						...								
		0	0	0	1	1	1	1	1	0	62	3E	5.813	
		0	0	0	1	1	1	1	1	1	63	3F	5.906	
		0	0	1	0	0	0	0	0	0	64	40	6.000	
		0	0	1	0	0	0	0	0	1	65	41	6.094	
						...								
		0	1	0	0	0	0	0	0	0	128	80	12.000	
						...								
		0	1	1	0	0	0	0	0	0	192	C0	18.000	
						...								
		0	1	1	1	1	1	1	1	0	254	FE	23.813	
		0	1	1	1	1	1	1	1	1	255	FF	23.906	
		1	0	0	0	0	0	0	0	0	256	100	23.906	
		1	0	0	0	0	0	0	0	1	257	101	23.906	
		1	0	0	0	0	0	0	1	0	258	102	23.906	
						...								3
		1	1	1	1	1	1	1	1	1	511	1FF	23.906	

NOTES :

1. Total gain is specified relative gain from the minimum gain.
2. Gain is always (35.906 dB, TYP.) for code greater than 382 (decimal).
3. Gain is always (23.906 dB, TYP.) for code greater than 254 (decimal).

1. Register name Black level
2. Register address
   [Write]

A_3	A_2	A_1	A_0
0	0	1	1

3. Register bit assignment

	D_9	D_8	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0
Default	X	X	X	1	0	0	0	0	0	0
Functions										
Black level				<----------						---------->

X : Don't care

4. Register operations

	OPERATIONS [ADC CODE : BINARY]										BLACK CODE		NOTE
	B_9	B_8	B_7	B_6	B_5	B_4	B_3	B_2	B_1	B_0	DECIMAL	HEX	
Black level				0	0	0	0	0	0	0	FORBIDDEN	FORBIDDEN	
				0	0	0	0	0	0	1	1	1	1
							...						1
				0	0	0	1	1	1	1	15	F	1
				0	0	1	0	0	0	0	16	10	
				0	0	1	0	0	0	1	17	11	
				0	0	1	0	0	1	0	18	12	
				0	0	1	0	0	1	1	19	13	
							...						
				0	1	0	0	0	0	0	32	20	
							...						
				1	0	0	0	0	0	0	64	40	
							...						
				1	1	1	1	1	0	0	124	7C	
				1	1	1	1	1	0	1	125	7D	
				1	1	1	1	1	1	0	126	7E	
				1	1	1	1	1	1	1	127	7F	

NOTE :

1. Codes 1 to 15 are available but not recommended. Black calibration period is specified under 15 < code < 128.

1. Register name Test (1)
2. Register address
   [Write]

A_3	A_2	A_1	A_0
0	1	0	0

3. Register bit assignment

	D_9	D_8	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0
Default	X	0	0	0	0	0	0	0	0	0
Functions										
ADIN test mode		<->								

NOTE : X : Don't care

D_7 to D_0 must always be "0".

4. Register operations

	CONTROLS										OPERATIONS
	D_9	D_8	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0	
ADIN test mode		0									Normal operation
		1									V_{COM} centered ADIN for AC coupling

The Test register (D_8) is for the AC coupled ADIN input mode. At this mode, the DC bias becomes the V_{COM} voltage and no clamp signals are required. Connect a 50 kΩ resistor between the ADIN (pin 14) and CLPCAP (pin 13), and input the signal to the ADIN pin via a capacitor.

1. Reference name Test (2)
2. Register address
   [Write]

A_3	A_2	A_1	A_0
0	1	0	1

3. Register bit assignment

	D_9	D_8	D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0
Default	X	X	X	X	X	X	0	0	0	0
Functions										
Test modes							<----------			>

NOTE : X : Don't care

D_3 to D_0 must always be "0".

ABSOLUTE MAXIMUM RATINGS

(AV_{SS} = DV_{SS} = 0 V, all voltages are with respect to GND.)

PARAMETER	SYMBOL	CONDITIONS	RATING	UNIT	NOTE
Power supply voltage	AV_{DD}		−0.3 to +4.5	V	
	DV_{DD}		−0.3 to +4.5 or AV_{DD} + 0.3	V	1
Voltage difference	V_{DLT}	DV_{DD} − AV_{DD}	0.3	V	
Power consumption	P_D	$T_A \leq 25°C$	570	mW	
P_D derating ratio		$T_A > 25°C$	4.5	mW/°C	
Input current	I_{IN}	Except power supply pins	±10	mA	
Analog input voltage	V_{INA}		AVss − 0.3 to AV_{DD} + 0.3	V	
Digital input voltage (Input pin)	V_{INL}		AVss − 0.3 to AV_{DD} + 0.3	V	
Digital input voltage (Output pin)	V_{ONL}		AVss − 0.3 to AV_{DD} + 0.3	V	2
Operating temperature	T_{OPR}		−30 to +85	°C	
Storage temperature	T_{STG}		−40 to +125	°C	

NOTES :

1. The higher voltage of 4.5 V or AV_{DD} + 0.3 V specifies maximum value of DV_{DD} absolute maximum rating.
2. The V_{ONL} limits the excess voltage applied to digital output pins.

WARNING :

Operation at or beyond these limits may result in permanent damage to the device. Normal operating specifications are not guaranteed at these extremes.

RECOMMENDED OPERATING CONDITIONS

(AV_{SS} = DV_{SS} = 0 V, all voltages are with respect to GND.)

PARAMETER		SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply voltage	Analog	AV_{DD}	At start-up, turn on AV_{DD} before (or at	2.7	3.0	3.6	V
	Digital output	DV_{DD}	the same time as) turning on DV_{DD}.	2.7	3.0	AV_{DD}	V

ELECTRICAL CHARACTERISTICS

Supply Current (NOTE 1)

(T_A = +25°C, AV_{DD} = DV_{DD} = 3.0 V)

PARAMETER		SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	NOTE
Supply current at	Analog	I_{A33}	fs = 36 MHz		50	60	mA	2
normal operation	Digital	I_{D33}			5	8	mA	2, 3
Supply current at monitor active		I_{PE}	fs = 36 MHz		52	63	mA	3
Supply current at power down		I_{PD}				0.1	mA	4

NOTES :

1. Specified at a 4.7 kΩ AISET resistance. Use a high precision resistor because it influences the supply current.
2. Specified when the monitor function is off.
3. Measured when connecting 10 pF capacitors between D_0 to D_9 pins and GND, and inputting full scale of 1 MHz sine wave to the ADC.
4. Measured under no analog input and with clock fixed at low.

Analog Specifications

(Unless otherwise specified, AV_{DD} = DV_{DD} = 3.0 V, T_A = +25°C, signal frequency f_{IN} = 1 MHz, signal level = full scale – 1 dB)

The current direction flowing into the pin is positive direction.

CDS & CLAMP CIRCUITS

(Sampling frequency fs = 36 MHz)

PARAMETER	SYMBOL	CONDITIONS		MIN.	TYP.	MAX.	UNIT	NOTE
Analog input range	V_{ICDS}	CCDIN input			1.1		Vp-p	1
	V_{IAI}	ADIN input			1.1		Vp-p	
Equivalent input noise	NI	At fs = 36 MHz	At max. gain		50		μV_{rms}	2
			At min. gain		200		μV_{rms}	
Input capacitance	C_{IN}	CCDIN, ADIN & REFIN			15		pF	
Input bandwidth	CBW					1	pixel	3
Clamp voltage	V_{CLPCAP}	CCDIN input		1.7	1.85	2.0	V	
		ADIN input		1.2	1.35	1.5	V	
Black calibration time	t_{BKCAL}					3000	pixel	4

NOTES :

1. The signal dynamic range is below the clamp voltage at the CCDIN input, and it is above the one at the ADIN input.
2. Measured at the MONOUT pin. The noise bandwidth is 100 kHz to 5 MHz.
3. The bandwidth from the CCDIN/REFIN to the ADC. This is defined as the settling time of the ADC when the full scale – 1 dB step input is inputted (at min. gain).
4. The time that is needed to settle the average value within ±1 LSB for the set code when the black level of 0 to 50% of the full scale is input. (The OBCAP capacitor is 0.033 µF.)
   The value of the OBCAP capacitor determines the bandwidth of the black calibration loop. The loop gain is also affected by the operation frequency. Therefore, the maximum frequency that is needed to settle within a limited time and the minimum frequency that is needed to avoid the undesirable oscillation are defined corresponding with the external capacitance. Refer to the table below to select the capacitance.

External Capacitance & Maximum and Minimum Conversion Frequency

PARAMETER	OBCAP	MIN.	MAX.	UNIT
Conversion frequency	0.033 µF	9.6	36	MHz
	0.1 µF	2.8	10	MHz
	0.33 µF	0.9	3.4	MHz

TOTAL GAIN

PARAMETER		SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	NOTE
CCDIN input	Minimum gain	GMNN	Absolute gain	−1.9	−0.9	0.1	dB	1
	Maximum gain	GMXN	Relative gain	34.906	35.906	36.906	dB	
	Gain step	GST		0	0.094	0.188	dB	
ADIN input	Minimum gain	GMNNA	Absolute gain	−1.35	−0.35	0.65	dB	1
	Maximum gain	GMXNA	Relative gain	22.906	23.906	24.906	dB	
	Gain step	GSTA		0	0.094	0.188	dB	
Total (CDS + PGA) gain monotonicity		ERPA				±1	LSB	2

NOTES :

1. Measured at the digital output pins (DO_0 to DO_9). When the input voltage is 1.0 Vp-p and ADC output is the full scale, the absolute gain is defined as a 0 dB. The relative gain is the relative value from the absolute gain. The gain monotonicity is guaranteed.
2. Measured at the digital output pins (DO_0 to DO_9).

A/D CONVERTER CIRCUIT

(f_S = 36 MHz, Input signals to ADIN.)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	NOTE
Resolution	RES				10	bits	
Integral nonlinearity	INL	fs = 36 MHz		±2.0	±2.5	LSB	
Differential nonlinearity	DNL			±0.8	±1.3	LSB	
S/N	SN			56		dB	
S/(N + D)	SND			54		dB	
ADC common voltage	VCOM		1.0	1.1	1.2	V	
VREF voltage (positive)	VRP		1.25	1.35	1.45	V	
VREF voltage (negative)	VRN		0.75	0.85	0.95	V	
ADC output black level calibration code	CCAL		16		127	LSB	
			1		127	LSB	1
Calibration code resolution	STCAL			1		LSB	

NOTE :

1. Black level calibration period (t_{BKCAL}) is specified when the C_{CAL} is from 16 to 127 LSB.
   Although black level codes of 1 to 15 could be set, t_{BKCAL} is not guaranteed for these codes.

Switching Characteristics

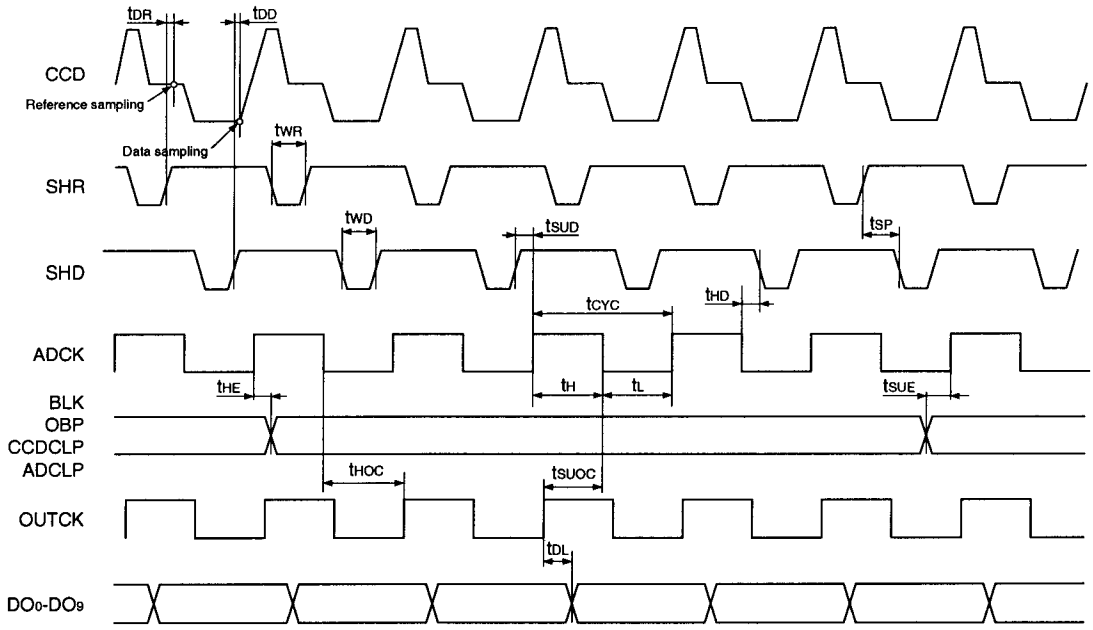
(AV_{DD}, DV_{DD} = 3.0 V, AV_{SS}, DV_{SS} = 0 V, T_A = −30 to +85°C, C_L = 10 pF)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	NOTE
Conversion frequency	f_S		0.5		36	MHz	
Clock cycle time	t_{CYC}		27.78			ns	
Clock rise time	t_R	(30%→70%) AV_{DD}, DV_{DD}			2	ns	
Clock fall time	t_F	(70%→30%) AV_{DD}, DV_{DD}			2	ns	
Clock low period	t_L		11.89			ns	
Clock high period	t_H		11.89			ns	
SHR pulse width	t_{WR}		7			ns	
SHD pulse width	t_{WD}		7			ns	
SHR sampling aperture	t_{DR}				3	ns	
SHD sampling aperture	t_{DD}				3	ns	
Data pulse setup	t_{SUD}		−0.5			ns	1
Data pulse hold	t_{HD}		2.5			ns	
Sampling pulse non-overlap	t_{SP}		1			ns	
Enable pulse setup	t_{SUE}		10			ns	
Enable pulse hold	t_{HE}		10			ns	
OUTCK setup	t_{SUOC}		0			ns	
OUTCK hold	t_{HOC}		10			ns	
ADC output data delay	t_{DL}		5		20	ns	
3 state disable delay	t_{DLD}	Active→High-Z		20		ns	
3 state enable delay	t_{DLE}	High-Z→Active		20		ns	

NOTE :

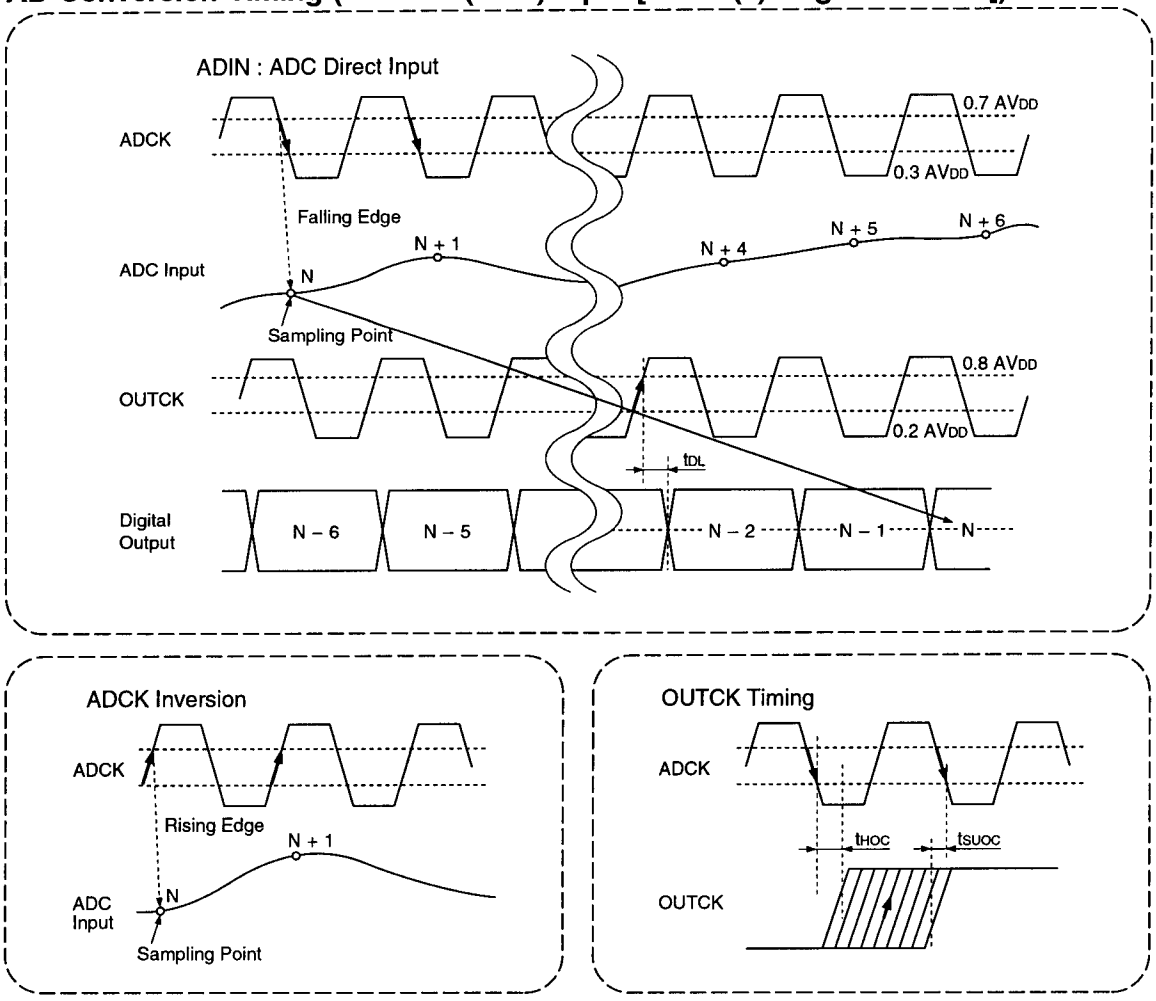
1. When SHD ↑ is earlier than ADCK ↑, assumed positive.
   (In the above table, SHD ↑ can be delayed a maximum of 0.5 ns behind ADCK ↑.)

TIMING CHART



This chart is shown when the Mode (1) D6 bit is set to "0", and an external clock is input to the OUTCK pin.

AD Conversion Timing (At ADIN (ADC) Input [Mode (1) Register D_5 = 1])



These figures are shown when the Mode (1) D_6 bit is set to "0", and an external clock is input to the OUTCK pin.

NOTE :

At default condition in ADIN mode, data are sampled at the falling edge of the ADCK clock, and are output at the rising edge of the OUTCK clock. When the data are sampled and are output at the falling edge of the ADCK clock, set ADCK polarity register to "1". When ADCK is inverted by register OUTCK input clock is invalid. Digital output D_0 to D_9 are output delayed from ADCK ↑ by T_{DL}.

(The upper figure on the previous page shows default timing, and the lower left figure on the previous page shows inverted timing.)

Delay from data sampling to data output

ADCK normal : At [Mode (1) Register D_6 = 0]

5.5 clk delay

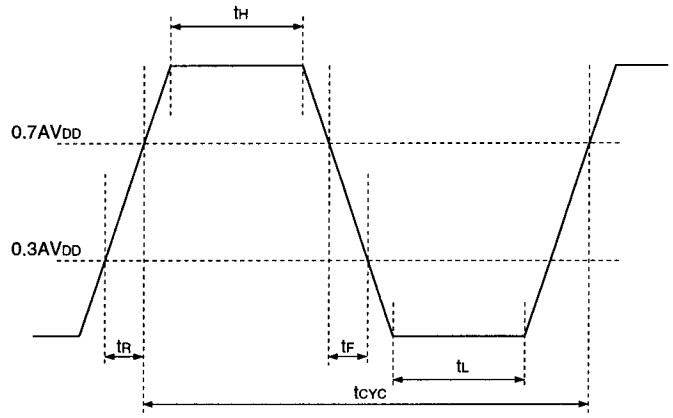
ADCK inversion : At [Mode (1) Register D_6 = 1]

6.0 clk delay

In ADIN input mode, the above-mentioned register setting is available.

At ADIN (PGA) input [Mode (1) Register D_5 = 0 & D_4 = 1] digital data output is delayed from above timing by 2 clk.

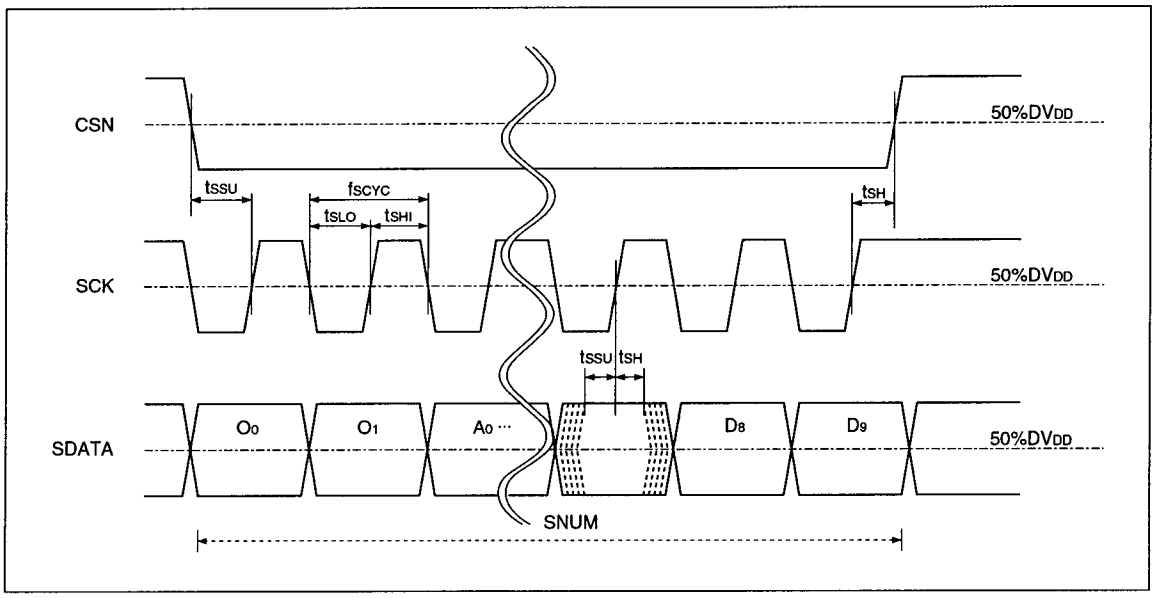
ADCK Clock Waveform



CONTROL INTERFACE TIMING

(AV_{DD}, DV_{DD} = 3.0 V, AV_{SS}, DV_{SS} = 0 V, T_A = −30 to +85°C)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
SCK clock cycle time	f_{SCYC}				10	MHz
SCK clock low width	t_{SLO}		40			ns
SCK clock high width	t_{SHI}		40			ns
Setup time	t_{SSU}		20			ns
Hold time	t_{SH}		20			ns
SCK, CSN rise time	t_{SR}	30%→70%			6	ns
SCK, CSN fall time	t_{SF}	70%→30%			6	ns
Serial data number	SNUM			16		pcs



Serial I/F Timing

Digital DC Characteristics

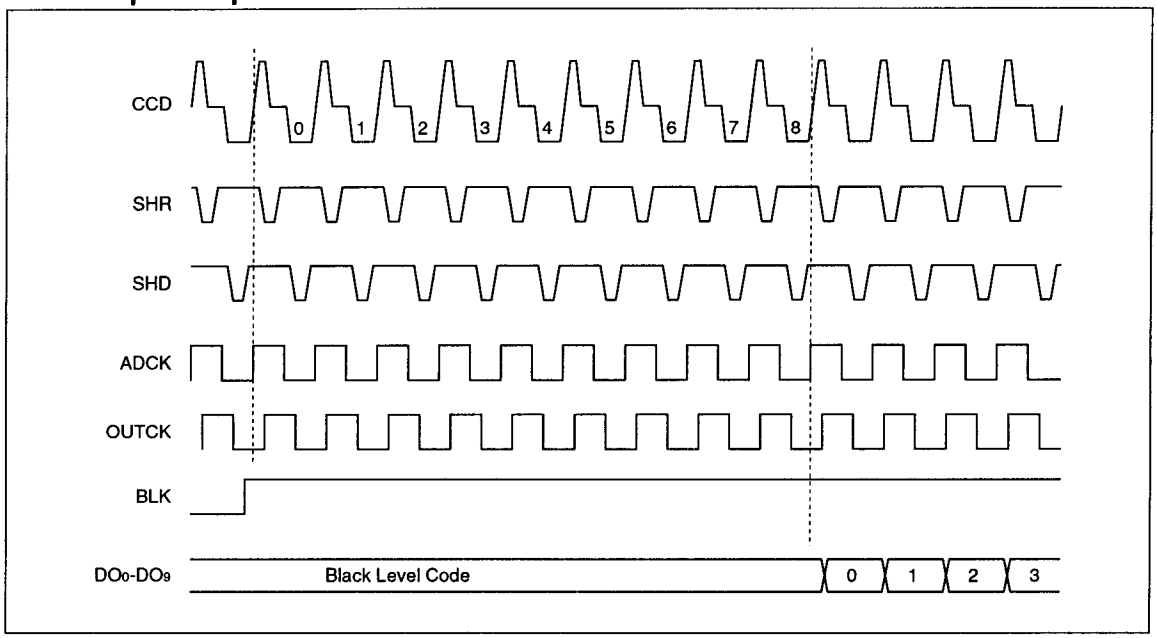
(AV_{DD}, DV_{DD} = 3.0 V, AV_{SS}, DV_{SS} = 0 V, T_A = −30 to +85°C, measured as DC characteristics.)

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT	NOTE
Input "Low" voltage	V_{IL1}				0.3AV_{DD}	V	1
Input "High" voltage	V_{IH1}		0.7AV_{DD}			V	
Input "Low" voltage	V_{IL2}				0.2AV_{DD}	V	2
Input "High" voltage	V_{IH2}		0.8AV_{DD}			V	
Output "Low" voltage	V_{OL}	I_{OL} = 1 mA			0.3DV_{DD}	V	
Output "High" voltage	V_{OH}	I_{OH} = −1 mA	0.7DV_{DD}			V	
Input "High" leakage current	I_{LING}				±10	µA	
High-Z leakage current	I_{OZ}				±10	µA	

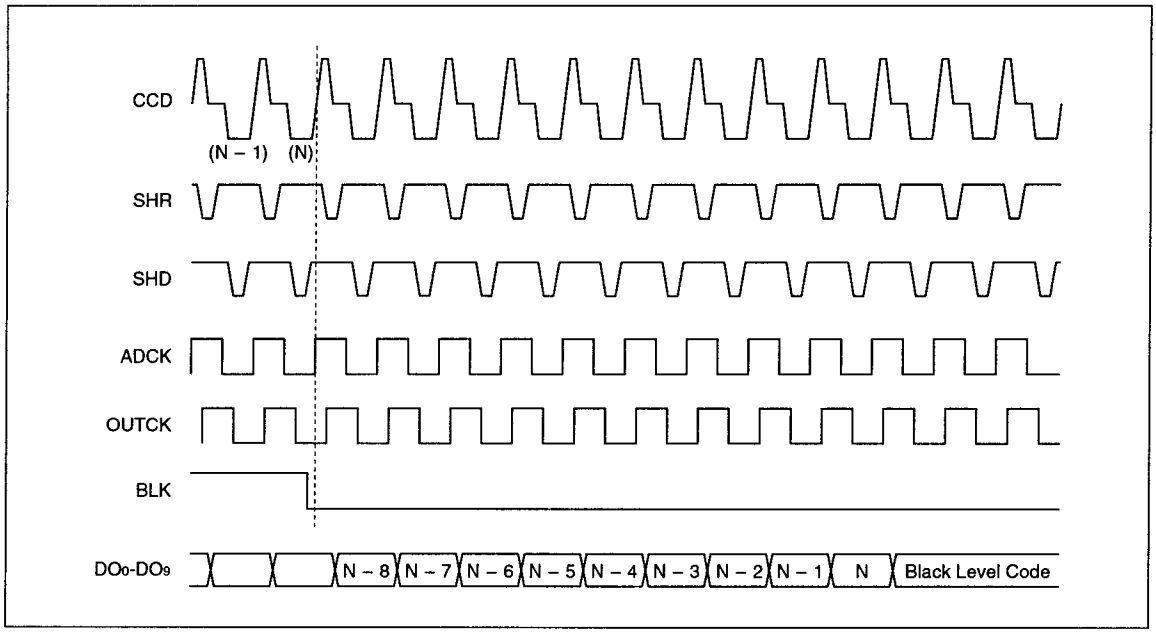
NOTES :

1. Applied for SHD, SHR, ADCK, BLK, OBP, CCDCLP, ADCLP, CSN, SCK and SDATA.
2. Applied to RESETN, STBYN and OUTCK.

Data Output Sequence



Pixel Data Readout Sequence (1) : Conversion Start



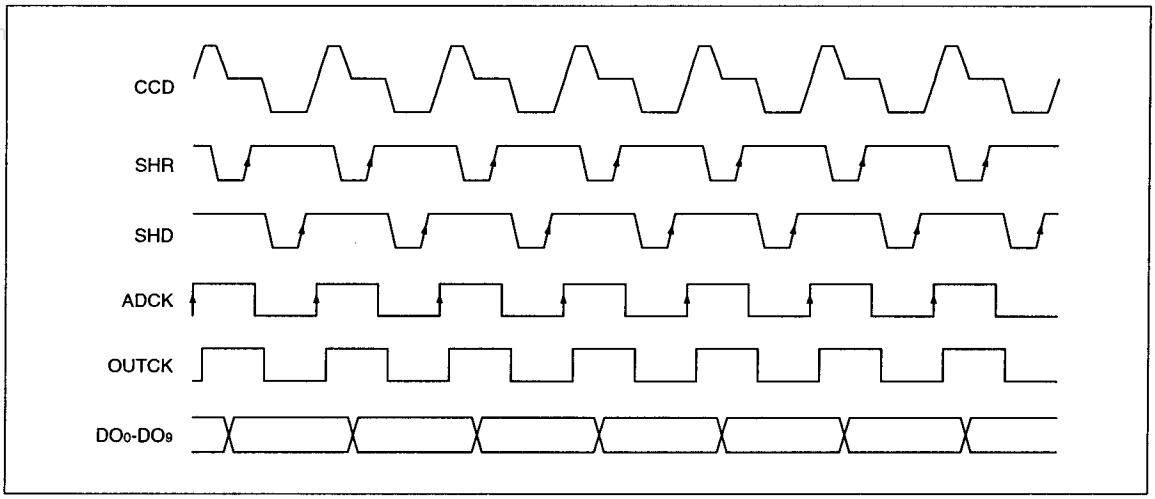
Pixel Data Readout Sequence (2) : Conversion End

Clock Timing Variations by Register Settings

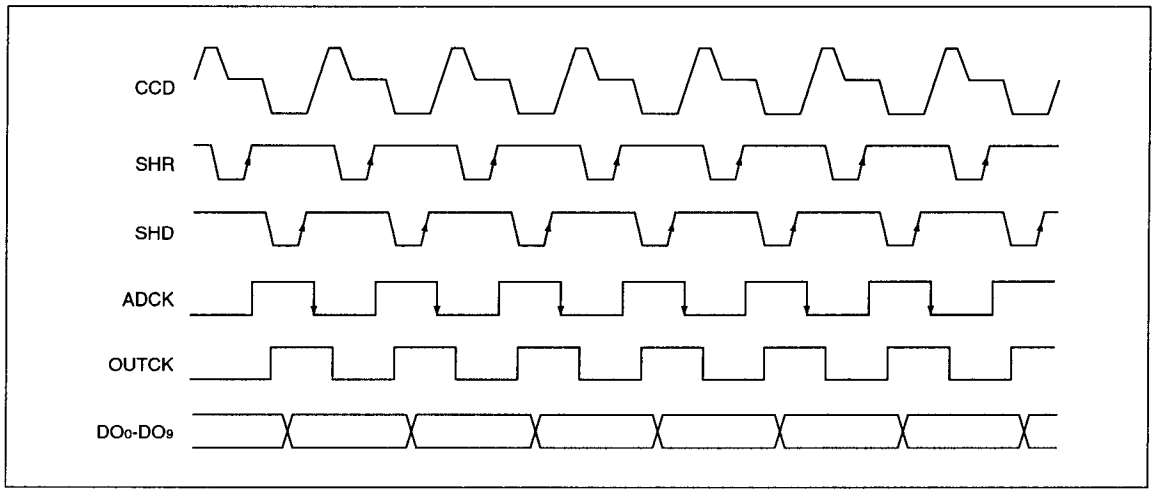
The variations of clock timings when it is inverted by register settings.

1. No inversion
   (Mode (1) Register D_6 = 0, Mode (2) Register D_2 = 0; Default) (Upper figure)
2. ADCK inversion
   (Mode (1) Register D_6 = 1, Mode (2) Register D_2 = 0) (Lower figure)

NOTE : D_0 to D_9 are output at the rising edge of ADCK in clock inversion mode.



Pulse Control (Default : No Inversion)

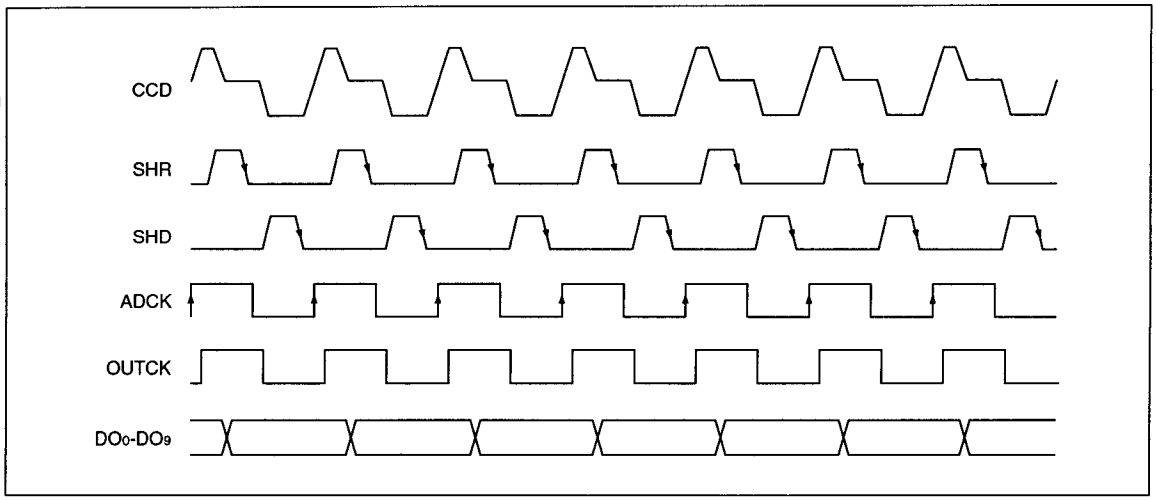


Pulse Control (ADCK Inversion)

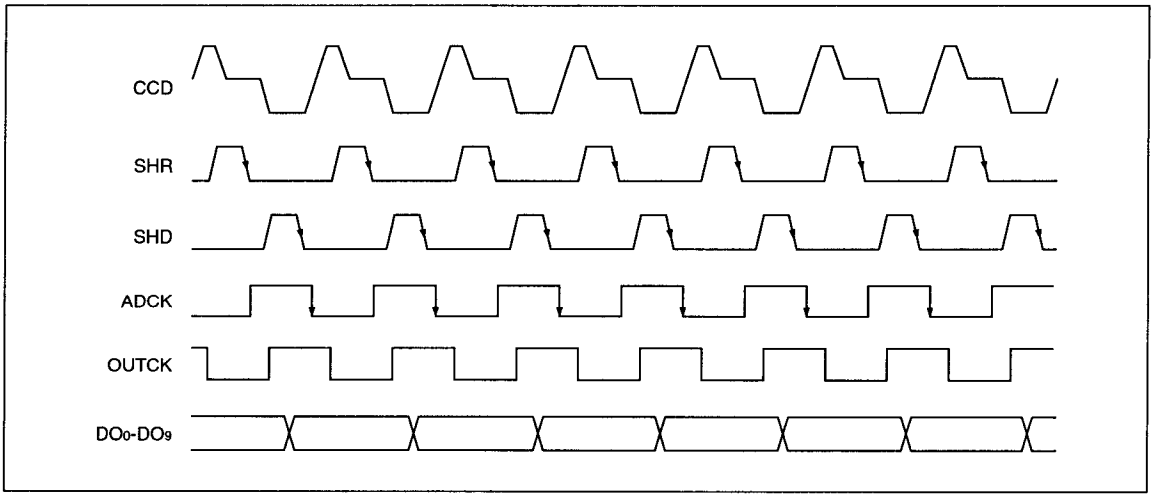
3. SHR & SHD inversion
(Mode (1) Register D_6 = 0, Mode (2) Register D_2 = 1) (Upper figure)

4. ADCK, SHR & SHD inversion
(Mode (1) Register D_6 = 1, Mode (2) Register D_2 = 1) (Lower figure)

NOTE : D_0 to D_9 are output at the rising edge of ADCK in clock inversion mode.



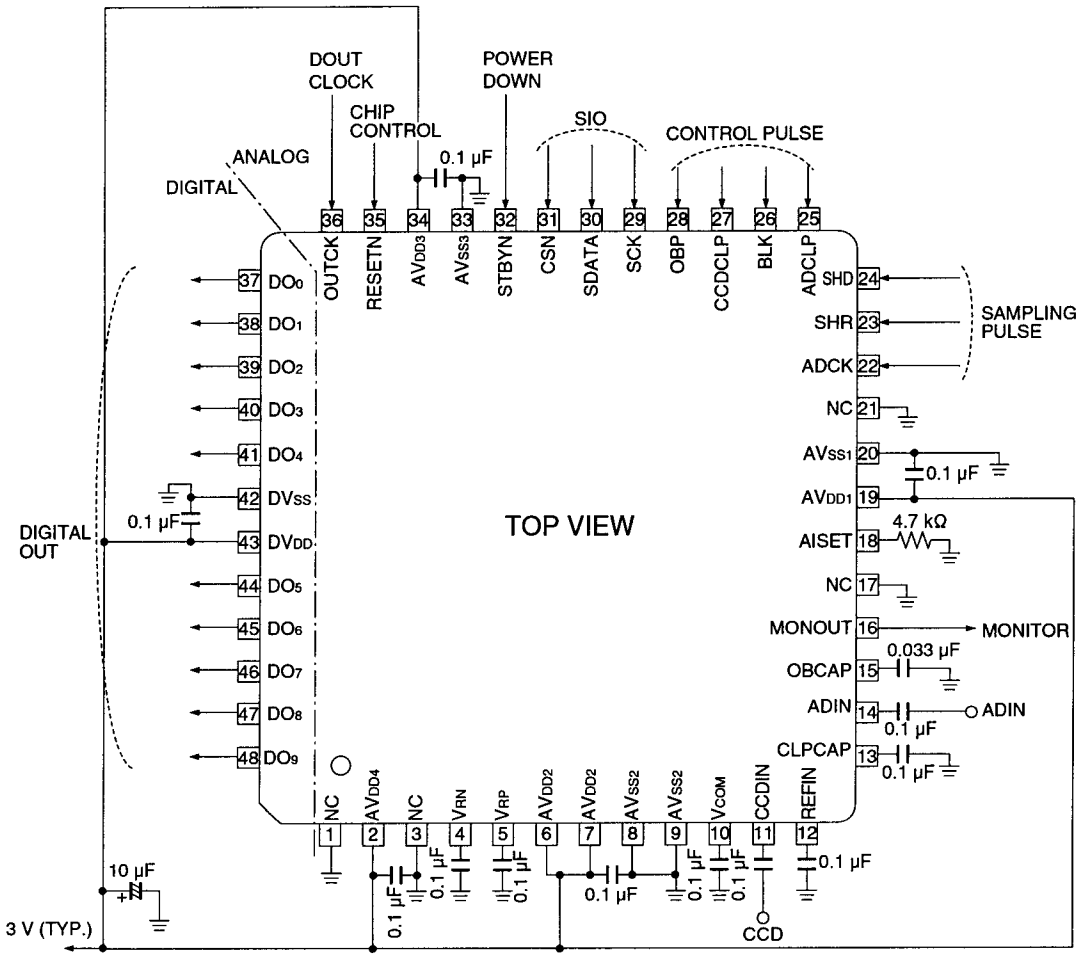
Pulse Control (SHR & SHD Inversion)



Pulse Control (ADCK, SHR & SHD Inversion)

APPLICATION CIRCUIT EXAMPLE

The following schematic is the reference circuit for system design.
Optimize capacitance and resistance according to the system environment.



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